# Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
	Forward current	١ <sub>F</sub>	60	mA
	Peak forward current (1us, pulse)	I <sub>FP</sub>	I <sub>FP</sub> 1	
Input	Reverse voltage	V <sub>R</sub>	6	V
	Power Dissipation No derating required up to $T_a = 100^{\circ}C$	P <sub>D</sub>	100	mW
	Power dissipation	5	150	mW
Output	Derating factor (above $T_a = 80^{\circ}C$ )	P <sub>C</sub> —	5.8	mW/°C
	Collector current	Ι <sub>C</sub>	50	mA
	Collector-Emitter voltage	V <sub>CEO</sub>	80	V
	Emitter-Collector voltage	V <sub>ECO</sub>	6	V
Total Power Dissipation		P <sub>TOT</sub>	200	mW
Isolation Voltage*1		V <sub>ISO</sub>	V <sub>ISO</sub> 5000	
Operating	Operating Temperature		-55 to 110	
Storage Te	Storage Temperature		-55 to 125	°C
Soldering Temperature*2		T <sub>SOL</sub>	260	°C

#### Notes:

\*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together. \*2 For 10 seconds

# Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input								
Param	eter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Forward Voltage		V <sub>F</sub>	-	1.2	1.4	V	I <sub>F</sub> = 20mA	
Reverse Current		I <sub>R</sub>	-	-	10	μA	$V_R = 4V$	
Input capacitance		C <sub>in</sub>	-	30	250	pF	V = 0, f = 1kHz	
Output								
Parameter		Symbol	Min	Тур.	Max.	Unit	Condition	
Collector-Emitter dark current		I <sub>CEO</sub>	-	-	100	nA	$V_{CE} = 20V, I_F = 0mA$	
Collector-Emit		BV <sub>CEO</sub>	80	-	-	V	I <sub>C</sub> = 0.1mA	
Emitter-Collector breakdown voltage		BV <sub>ECO</sub>	6	-	-	V	I <sub>E</sub> = 0.1mA	
Transfer Cha	aracteristic	cs			E			
Param	eter	Symbol	Min	Тур.	Max.	Unit	Condition	
	EL816		50	-	600	%		
	EL816A		80	-	160			
	EL816B	_	130	-	260			
	EL816C	CTR	200	-	400		$I_F = 5 \text{mA}$ , $V_{CE} = 5 \text{V}$	
	EL816D		300	-	600			
	EL816X	_	100	-	200			
Current Transfer ratio	EL816Y		150	-	300			
	EL816I		63	-	125	%		
	EL816J		100	-	200		$I_F = 10mA$ , $V_{CE} = 5V$	
	EL816K	- 	160	-	320			
	EL816I	– CTR	22	-	-			
	EL816J		34	-	-		$I_{F} = 1 m A$ , $V_{CE} = 5 V$	

#### Transfer Characteristics (T<sub>a</sub>=25°C unless specified otherwise) Continuity

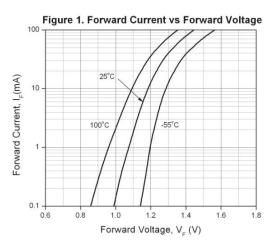
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition	
Collector-Emitter saturation voltage	V <sub>CE(sat)</sub>	-	0.1	0.2	V	$I_{F} = 20mA$ , $I_{C} = 1mA$	
Isolation resistance	R <sub>IO</sub>	5×10 <sup>10</sup>	-	-	Ω	V <sub>IO</sub> = 500Vdc, 40~60% R.H.	
Floating capacitance	C <sub>IO</sub>	-	0.6	1.0	pF	$V_{IO} = 0$ , f = 1MHz	
Cut-off frequency	fc	-	80	-	kHz	$V_{CE} = 5V, I_C = 2mA$ $R_L = 100\Omega, -3dB$	
Rise time	tr	-	4	18	μs	$V_{CE} = 2V, I_{C} = 2mA,$	
Fall time	t <sub>f</sub>	-	3	18	μs	$R_L = 100\Omega$	

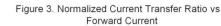
\* Typical values at T<sub>a</sub> = 25°C



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# **Typical Electro-Optical Characteristics Curves**





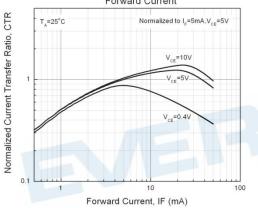


Figure 5. Collector Current vs Collector-Emitter Voltage

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Collector-Emitter Voltage, V<sub>CE</sub> (V)

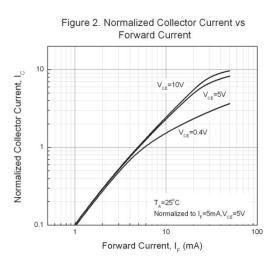
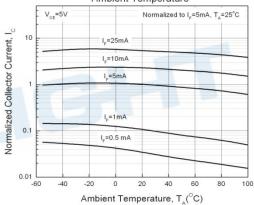
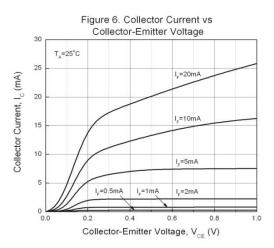


Figure 4. Normalized Collector Current vs Ambient Temperature





10

5

0

0

2

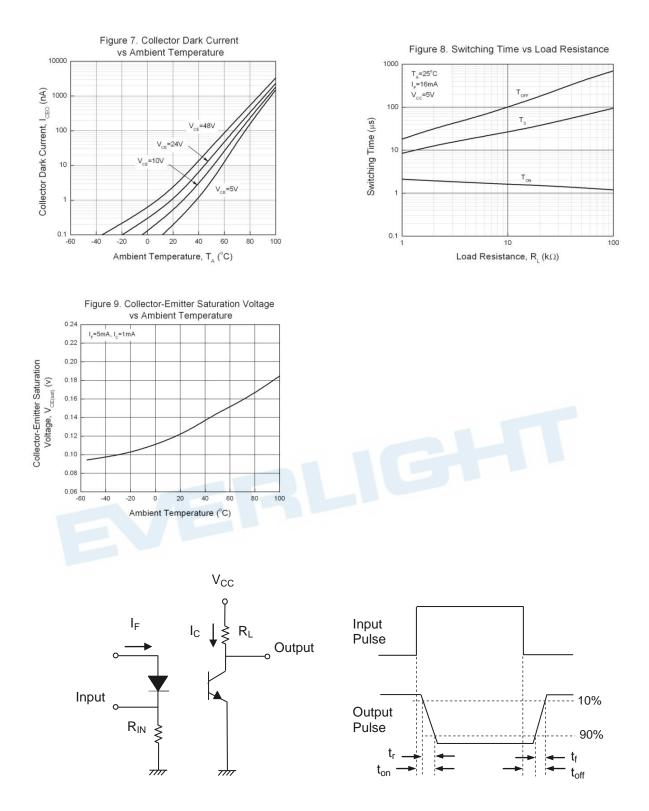


Figure 10. Switching Time Test Circuit & Waveforms

# **Order Information**

#### Part Number

# EL816X(Y)(Z)-FV

#### Note

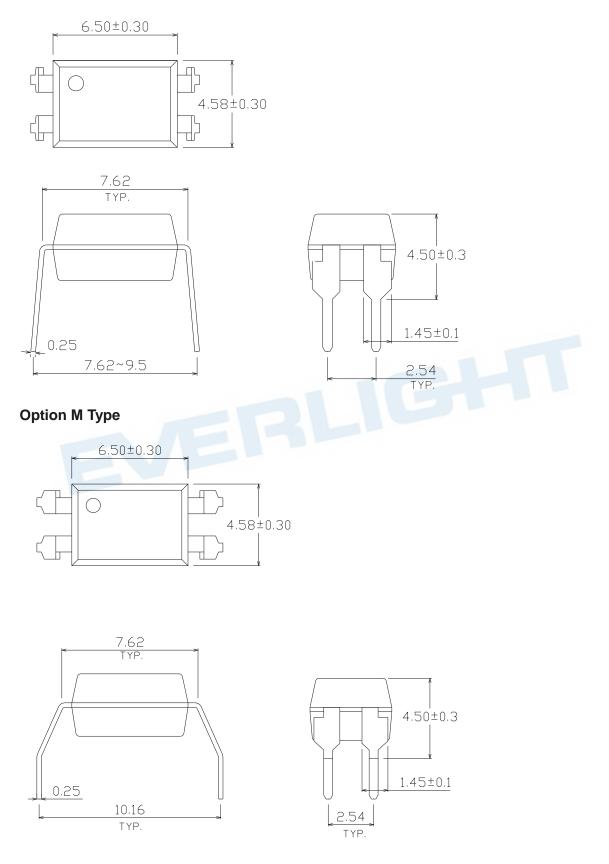
- X = Lead form option (S1, S2, M or none)
- Y = CTR Rank (A, B, C, D, X, Y, I, J, K or none)
- Z = Tape and reel option (TU, TD or none).
- F = Lead frame option (F: Iron, None: copper)
- V = VDE safety (optional).

Option	Description	Packing quantity
None	Standard DIP-4	100 units per tube
М	Wide lead bend (0.4 inch spacing)	100 units per tube
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	1500 units per reel
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	1500 units per reel
S2 (TU)	Surface mount lead form (low profile) + TU tape & reel option	2000 units per reel
S2 (TD)	Surface mount lead form (low profile) + TD tape & reel option	2000 units per reel
		•

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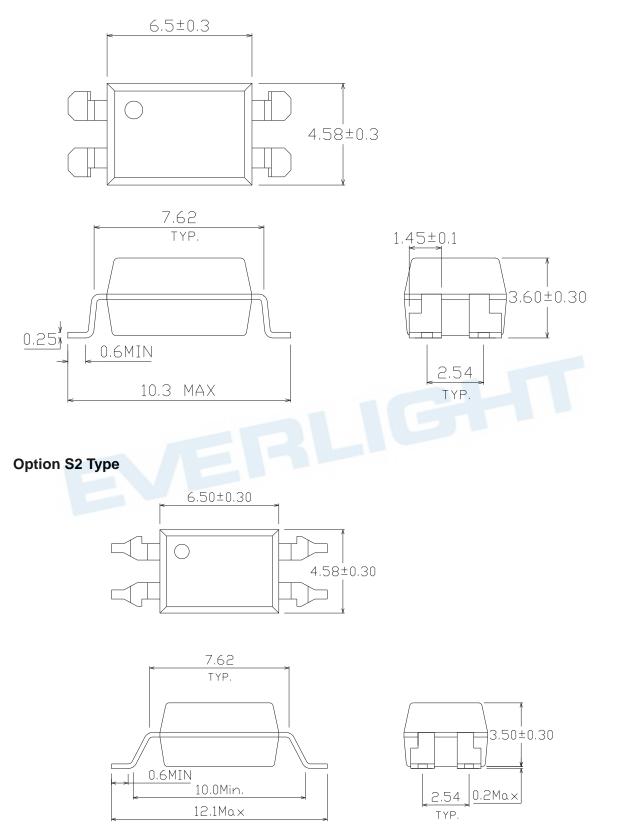
# Package Dimension (Dimensions in mm)

# Standard DIP Type



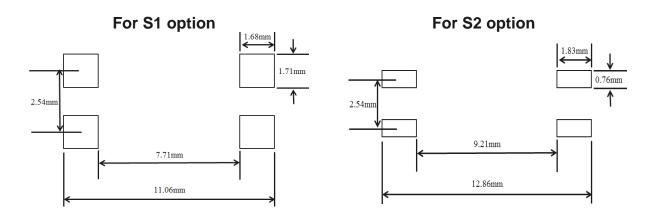


# **Option S1 Type**

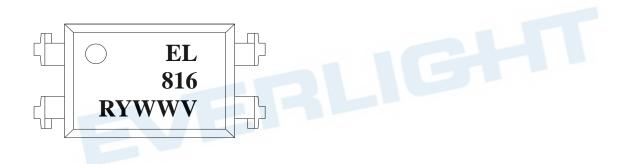




## Recommended pad layout for surface mount leadform



## **Device Marking**

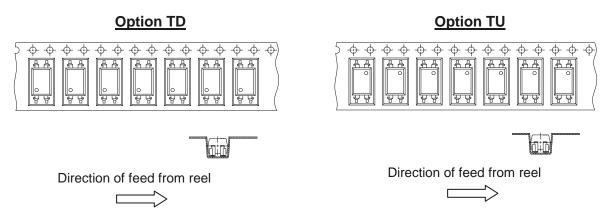


#### Notes

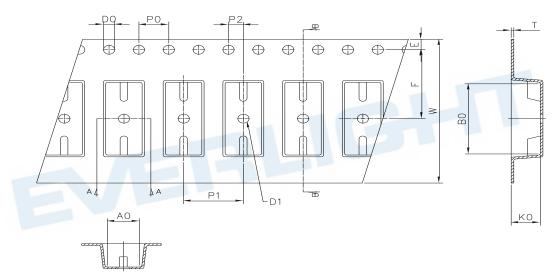
- EL denotes EVERLIGHT
- 816 denotes Device Number
- R denotes CTR Rank(A, B, C, D, X, Y, I, J, K or none)
- Y denotes 1 digit Year code
- WW denotes 2 digit Week code
- V denotes VDE (optional)



# **Tape & Reel Packing Specifications**



# **Tape dimensions**



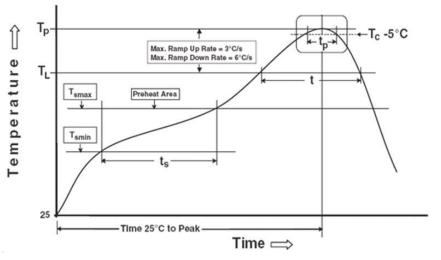
Dimension No.	Ao	Во	Do	D1	Е	F
Dimension (mm) S1	4.90±0.1	10.40±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.50±0.1
Dimension (mm) S2	4.88±0.1	12.55±0.1	1.5±0.1	1.50±0.1	1.75±0.1	11.5±0.1
Dimension No.	_					
Dimension NO.	Ро	P1	P2	t	W	Ко
Dimension (mm) S1	<b>Po</b> 4.00±0.1	<b>P1</b> 8.00±0.	<b>P2</b> 2.00±0.1	t 0.40±0.1	<b>W</b> 16.00±0.3	<b>Ko</b> 4.60±0.1



# **Precautions for Use**

#### 1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

#### Preheat

Temperature min ( $T_{smin}$ ) Temperature max ( $T_{smax}$ ) Time ( $T_{smin}$  to  $T_{smax}$ ) ( $t_s$ ) Average ramp-up rate ( $T_{smax}$  to  $T_p$ )

# 150 °C 200°C 60-120 seconds 3 °C/second max

Reference: IPC/JEDEC J-STD-020D

# Other

Liquidus Temperature ( $T_L$ ) Time above Liquidus Temperature ( $t_L$ ) Peak Temperature ( $T_P$ ) Time within 5 °C of Actual Peak Temperature:  $T_P - 5$ °C Ramp- Down Rate from Peak Temperature Time 25°C to peak temperature Reflow times 217 °C 60-100 sec 260°C 30 s 6°C /second max. 8 minutes max. 3 times

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